

Features

- Guardring for Stress Protection
- Low Forward Voltage
- Epoxy Meets UL 94 V-0
- Package Designed for Optimal Automated Board Assembly







Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MBR230LSFT1G	SOD-123FL	K24	3000

Maximum Ratings (Ta=25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Average Rectified Forward Current (At Rated V _R , T _L = 105°C)	I _O	2.0	Α
Peak Repetitive Forward Current (At Rated V _R , Square Wave, 100 kHz, T _L = 95°C)	I _{FRM}	4.0	А
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I _{FSM}	40	А
Storage Temperature	T _{stg}	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/μs

Electrical Characteristics (Ta=25°C unless otherwise specified)

Maximum Instantaneous Forward Voltage (Note 3)	V _F	$T_J = 25^{\circ}C$	$T_J = 100^{\circ}C$	V
$(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.38 0.43	0.30 0.37	
Maximum Instantaneous Reverse Current (Note 3)	I _R	$T_J = 25^{\circ}C$	T _J = 100°C	mA
$(V_R = 30 \text{ V})$		1.0	25	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width \leq 250 μ s, Duty Cycle \leq 2%.



Typical Characteristics

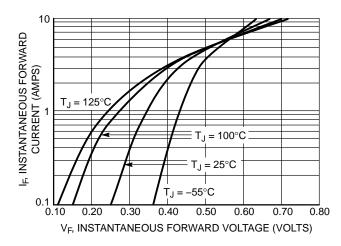


Figure 1. Typical Forward Voltage

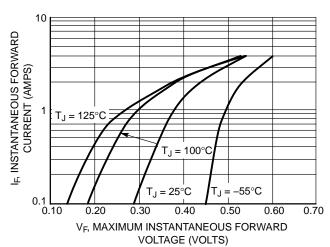


Figure 2. Maximum Forward Voltage

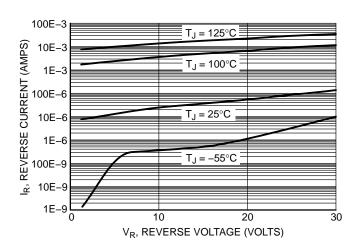


Figure 3. Typical Reverse Current

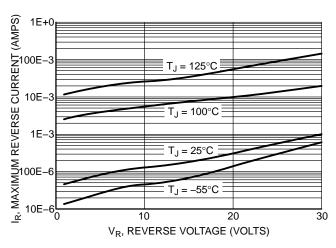


Figure 4. Maximum Reverse Current

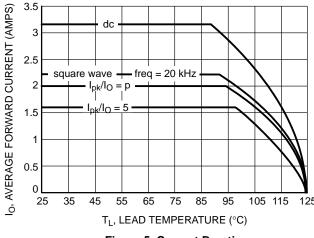


Figure 5. Current Derating

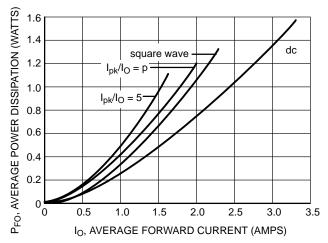
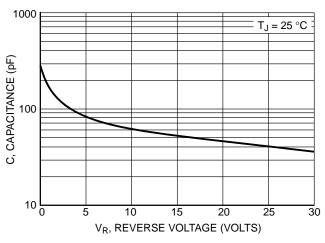


Figure 6. Forward Power Dissipation



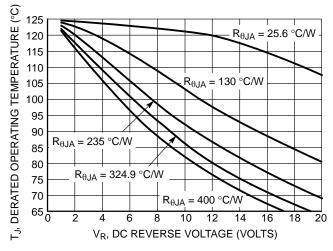


Figure 7. Capacitance

Figure 8. Typical Operating Temperature Derating

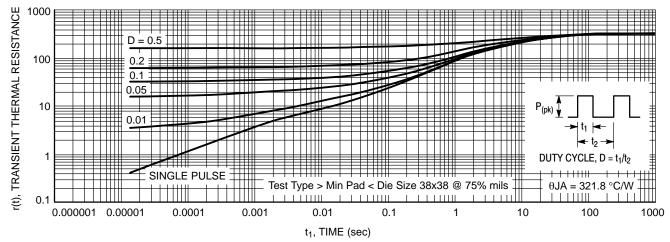
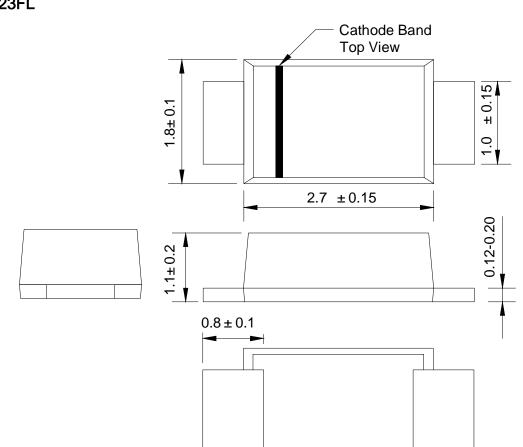


Figure 9. Thermal Response



Package Outline Dimensions SOD-123FL



 3.7 ± 0.15



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